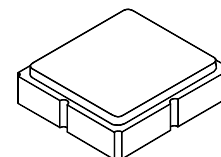


- **SAW Filter for Digital Television**
- **Complies with Directive 2002/95/EC (RoHS)**
- **Meets AEC-Q200 Standards**
- **Moisture Sensitivity Level: 1**

RoHS
Compliant

SF2166E

1280.18 MHz



SM3030-8

Characteristics:

Balance-to-balanced operation

Terminating source/load impedance : $Z_S = 150 \Omega$

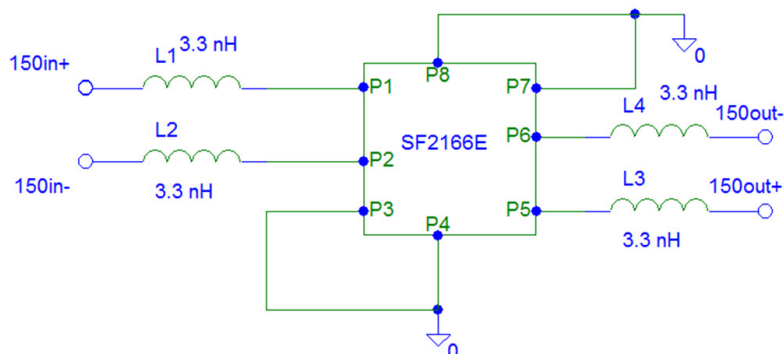
Maximum Rating

Rating	Value	Units
Input Power Level	+10	dBm
DC Voltage on any Non-ground Terminal	3	V
Operating Temperature Range	-40 to +85	°C
Storage Temperature Range	-50 to +95	°C
Maximum Soldering Profile, 5 cycles/ 10 seconds maximum	265	°C

Characteristic	Sym	Notes	Min	Typ	Max	Units
Center Frequency	f_c			1280.18		MHz
Insertion Loss, 1260.18 to 1300.18 MHz	IL			3.2	4.5	dB
Amplitude Ripple, 1260.18 to 1300.18 MHz				1.0	2.3	dB
Group Delay Ripple, 1260.18 to 1300.18 MHz				20	30	ns _{p-p}
Attenuation, 0 dB Reference:						
100 to 1198.12 MHz			47	50		dB
1362.24 to 2000 MHz			45	55		
2000 to 6000 MHz			30	40		

Case Style	SM3030-8 3.0 x 3.0 mm Nominal Footprint
Lid Symbolization (Y=year, WW=week, S=shift) dot=pin 1 indicator	858, YWWS

Tuning Network, 150 ohm Balanced Source/Load

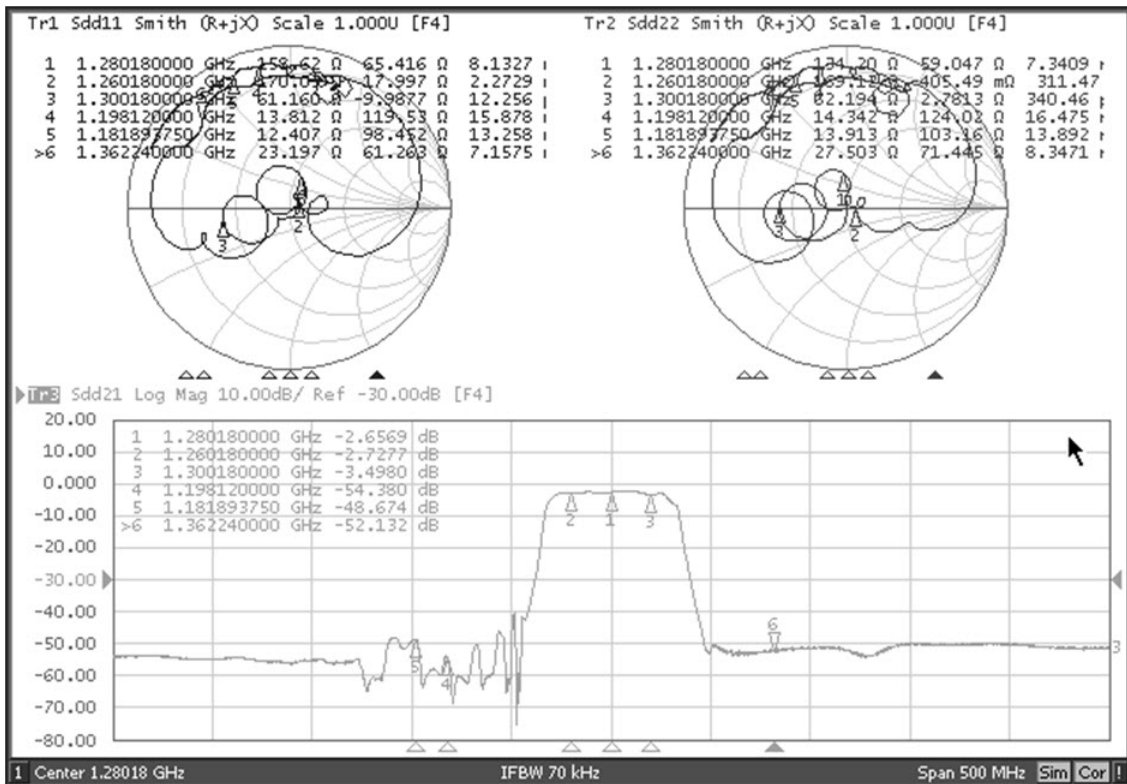


CAUTION: Electrostatic Sensitive Device. Observe precautions for handling.

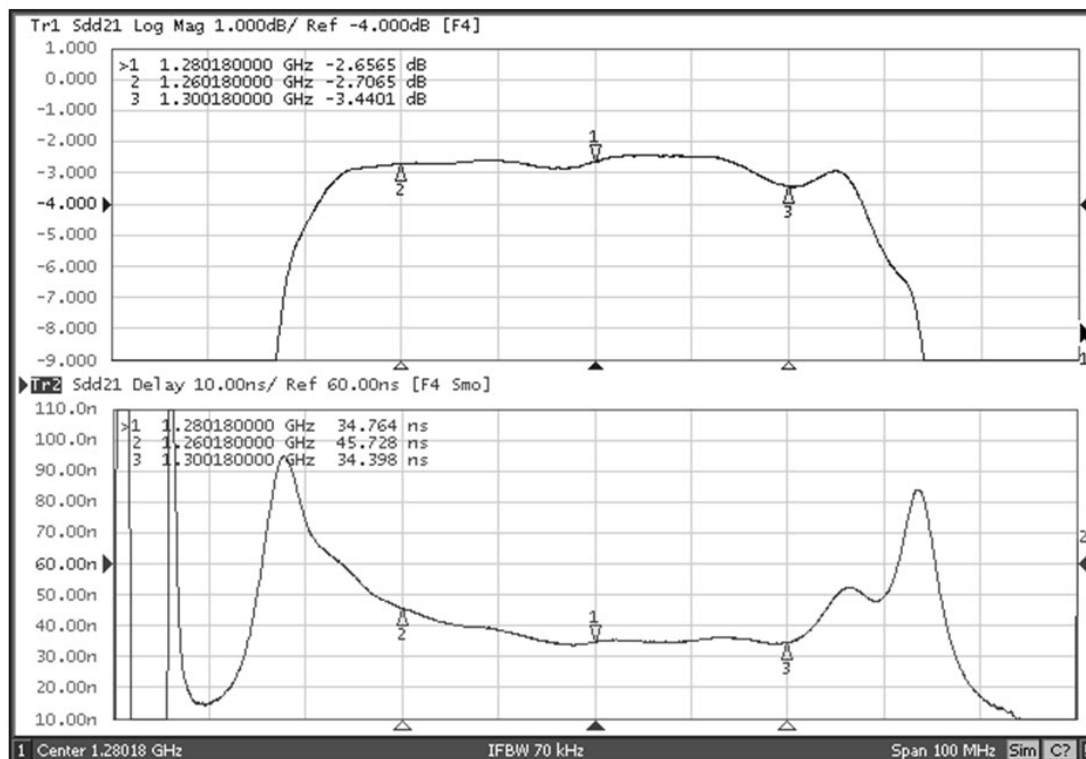
NOTES:

1. The design, manufacturing process, and specifications of this device are subject to change.
2. US or International patents may apply.
3. RoHS compliant from the first date of manufacture.

Filter S21, S11 and S22 Plots

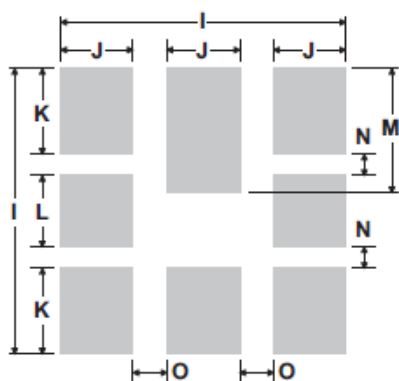
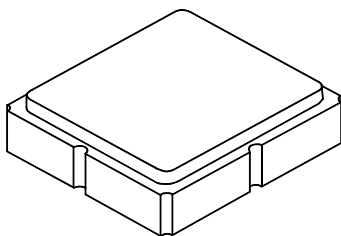


Filter Passband and Group Delay Plot



8-Terminal Ceramic Surface-Mount Case

3.0 X 3.0 mm Nominal Footprint



PCB Footprint Top View

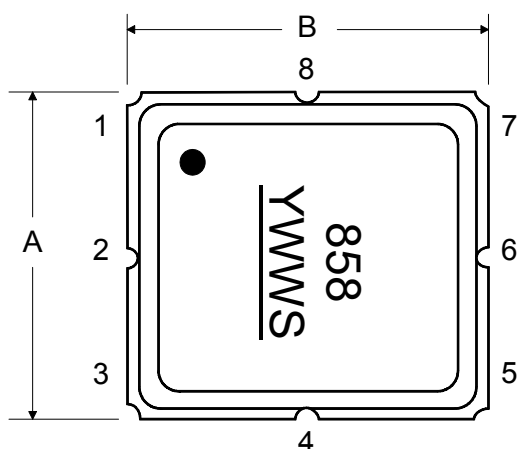
Case and PCB Footprint Dimensions

Dimension	mm			Inches		
	Min	Nom	Max	Min	Nom	Max
A	2.87	3.0	3.13	0.113	0.118	0.123
B	2.87	3.0	3.13	0.113	0.118	0.123
C	1.14	1.27	1.40	0.045	0.050	0.055
D	0.79	0.92	1.05	0.031	0.036	0.041
E	0.62	0.75	0.88	0.024	0.029	0.034
F	0.47	0.60	0.73	0.018	0.024	0.029
G	0.47	0.60	0.73	0.018	0.024	0.029
H	1.07	1.20	1.33	0.042	0.047	0.052
I	-	3.19	-	-	0.126	-
J	-	0.81	-	-	0.032	-
K	-	0.96	-	-	0.038	-
L	-	0.81	-	-	0.032	-
M	-	1.39	-	-	0.055	-
N	-	0.23	-	-	0.009	-
O	-	0.38	-	-	0.015	-

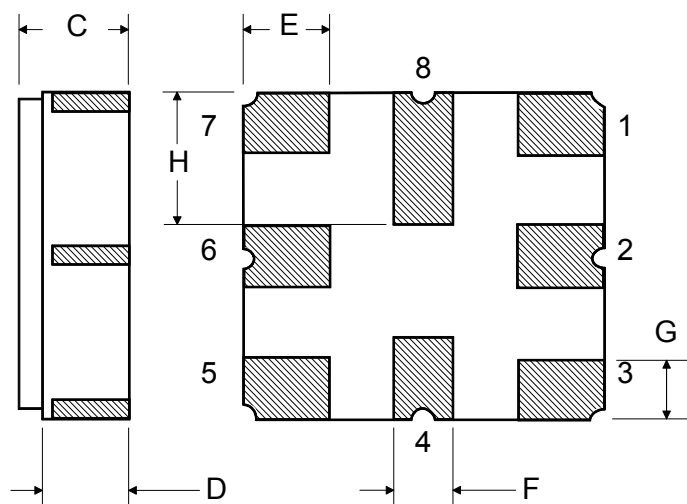
Case Materials

Materials	
Solder Pad Plating	0.3 to 1.0 μm Gold over 1.27 to 8.89 μm Nickel
Lid Plating	2.0 to 3.0 μm Nickel
Body	Al_2O_3 Ceramic

TOP VIEW

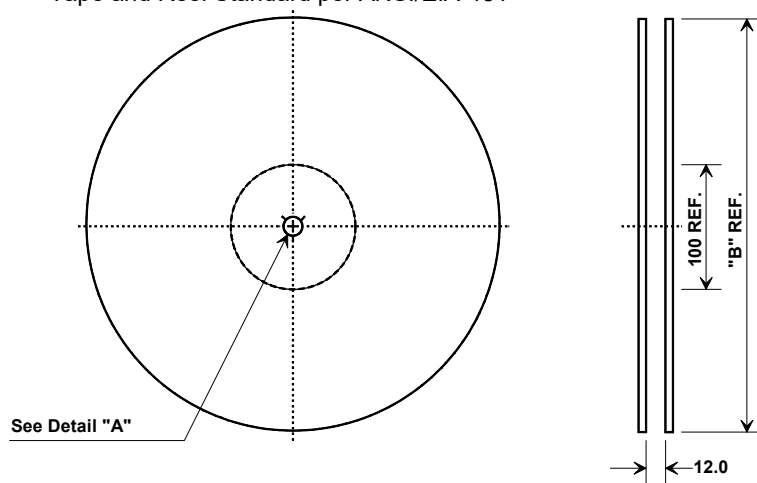


BOTTOM VIEW

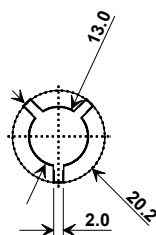


Tape and Reel Specifications

Tape and Reel Standard per ANSI/EIA-481

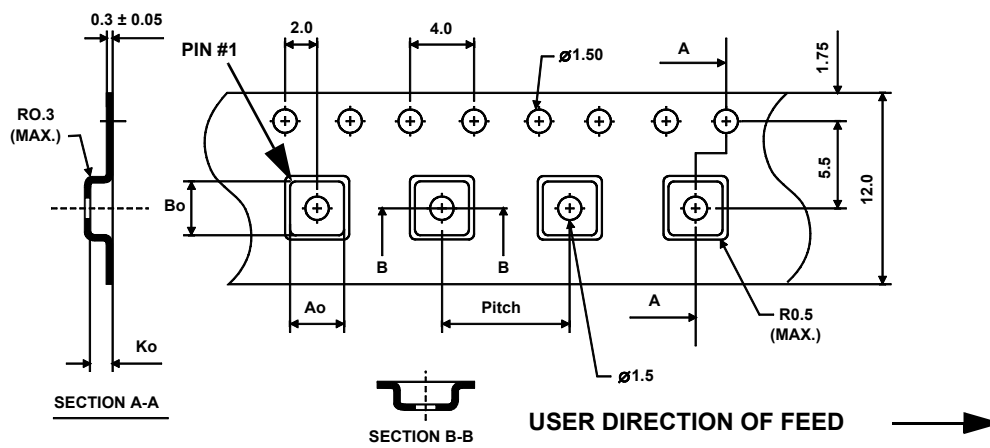


“B”		Quantity Per Reel
Inches	millimeters	
7	178	500
13	330	3000



COMPONENT ORIENTATION and DIMENSIONS

Carrier Tape Dimensions	
Ao	3.35 mm
Bo	3.35 mm
Ko	1.40 mm
Pitch	8.0 mm
W	12.0 mm



Recommended Reflow Profile

1. Preheating shall be fixed at 150~180°C for 60~90 seconds.
2. Ascending time to preheating temperature 150°C shall be 30 seconds min.
3. Heating shall be fixed at 220°C for 50~80 seconds and at 260°C +0/-5°C peak (10 seconds).
4. Time: 5 times maximum.

